

200mW, Dual PNP Small Signal Transistor

FEATURES

- AEC-Q101 qualified
- General-purpose transistors
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

- General switching and amplification

MECHANICAL DATA

- Case: SOT-363
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Weight: 6.99mg (approximately)



| KEY PARAMETERS | | |
|----------------|----------|------|
| PARAMETER | VALUE | UNIT |
| V_{CBO} | -50 | V |
| V_{CEO} | -45 | V |
| V_{EBO} | -5 | V |
| I_C | -200 | mA |
| h_{FE} | 630 | |
| Configuration | Dual die | |

| PACKAGE: SOT-363 | PIN CONFIGURATION | CIRCUIT DIAGRAM |
|------------------|-------------------|-----------------|
| | | |

| ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted) | | | |
|---|-----------|-------------|------------------|
| PARAMETER | SYMBOL | VALUE | UNIT |
| Power dissipation ⁽¹⁾ | P_D | 200 | mW |
| Collector-base voltage | V_{CBO} | -50 | V |
| Collector-emitter voltage | V_{CEO} | -45 | V |
| Emitter-base voltage | V_{EBO} | -5 | V |
| Collector current | I_C | -200 | mA |
| Junction temperature | T_J | -55 to +150 | $^\circ\text{C}$ |
| Storage temperature | T_{STG} | -55 to +150 | $^\circ\text{C}$ |

Note:

1. Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint

THERMAL PERFORMANCE

| PARAMETER | SYMBOL | TYP | UNIT |
|---|-----------------|-----|------|
| Junction-to-ambient thermal resistance ⁽¹⁾ | $R_{\theta JA}$ | 625 | °C/W |

Thermal Performance Note:

1. Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| PARAMETER | CONDITIONS | SYMBOL | MIN | TYP | MAX | UNIT |
|--------------------------------------|--|---------------|------|-----|-------|------|
| Collector-base breakdown voltage | $I_C = -10\mu\text{A}$, $I_E = 0\text{A}$ | $V_{(BR)CBO}$ | -50 | - | - | V |
| Collector-emitter breakdown voltage | $I_C = -10\text{mA}$, $I_B = 0\text{A}$ | $V_{(BR)CEO}$ | -45 | - | - | V |
| Emitter-base breakdown voltage | $I_E = -10\mu\text{A}$, $I_C = 0\text{A}$ | $V_{(BR)EBO}$ | -5 | - | - | V |
| Collector-base cut-off current | $V_{CB} = -30\text{V}$, $I_E = 0\text{A}$ | I_{CBO} | - | - | -15 | nA |
| DC current gain | $V_{CE} = -5\text{V}$, $I_C = -2\text{mA}$ | h_{FE} | 125 | - | 630 | - |
| Collector-emitter saturation voltage | $I_C = -10\text{mA}$, $I_B = -0.5\text{mA}$ | $V_{CE(sat)}$ | - | - | -0.30 | V |
| | $I_C = -100\text{mA}$, $I_B = -5\text{mA}$ | | - | - | -0.65 | |
| Base-emitter voltage | $V_{CE} = -5\text{V}$, $I_C = -2\text{mA}$ | V_{BE} | -600 | - | -750 | mV |
| | $V_{CE} = -5\text{V}$, $I_C = -10\text{mA}$ | | - | - | -820 | |
| Transition frequency | $V_{CE} = -5\text{V}$, $I_C = -10\text{mA}$, $f = 100\text{MHz}$ | f_T | - | 200 | - | MHz |
| Output capacitance | $V_{CB} = -10\text{V}$, $I_E = 0\text{A}$, $f = 1\text{MHz}$ | C_{obo} | - | 3.5 | - | pF |

ORDERING AND MARKING INFORMATION

| ORDERING CODE | PACKAGE | PACKING |
|---------------|---------|------------------------|
| BC857SH RFG | SOT-363 | 3,000 / 7" Tape & Reel |

CHARACTERISTICS CURVES

Fig.1 Power Dissipation Curve

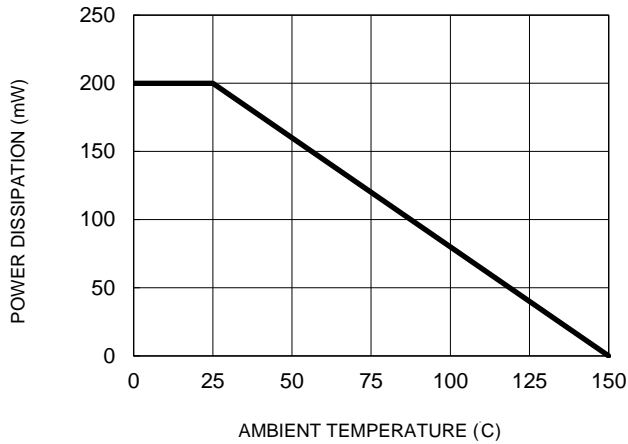


Fig.2 Typical Capacitance Characteristics

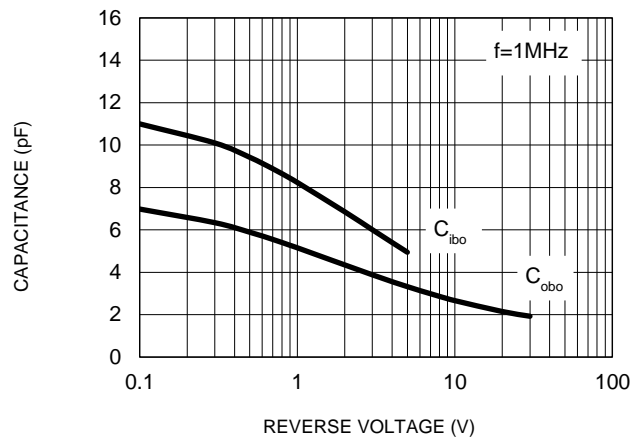


Fig.3 DC Current Gain vs. Collector Current

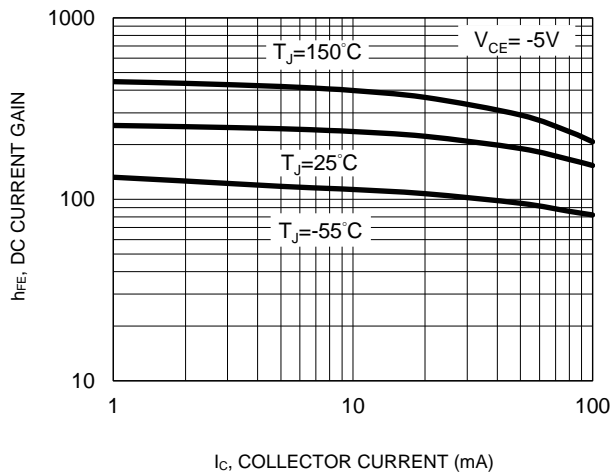


Fig.4 Collector-Emitter Saturation Voltage vs. Collector Current

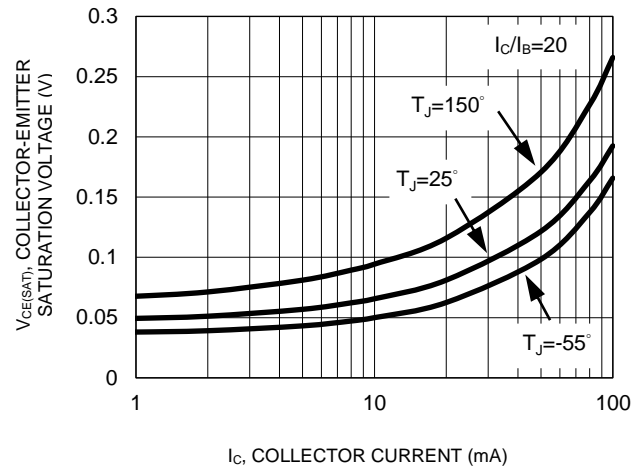


Fig.5 Base-Emitter Saturation Voltage vs. Collector Current

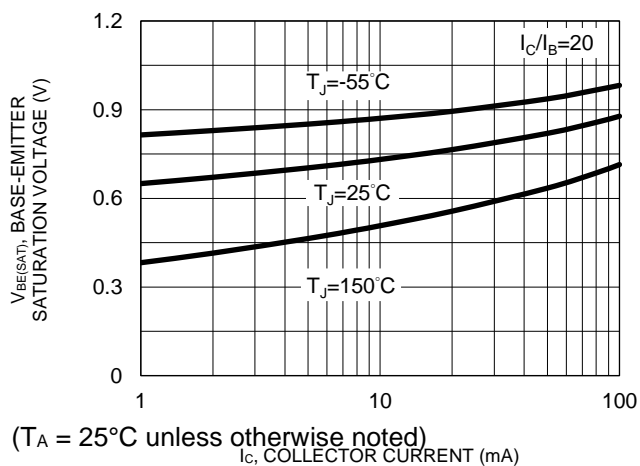
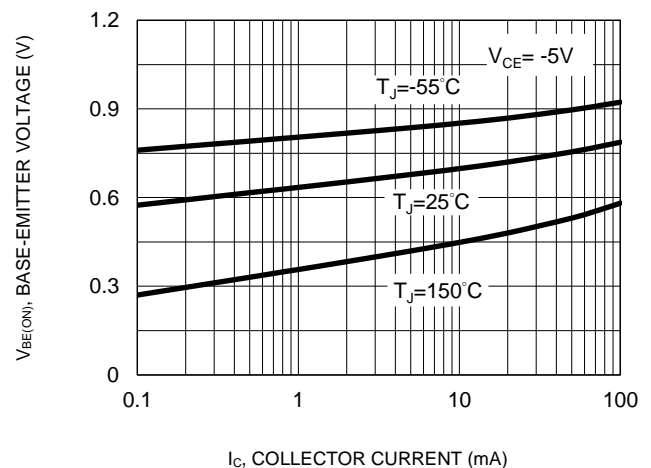


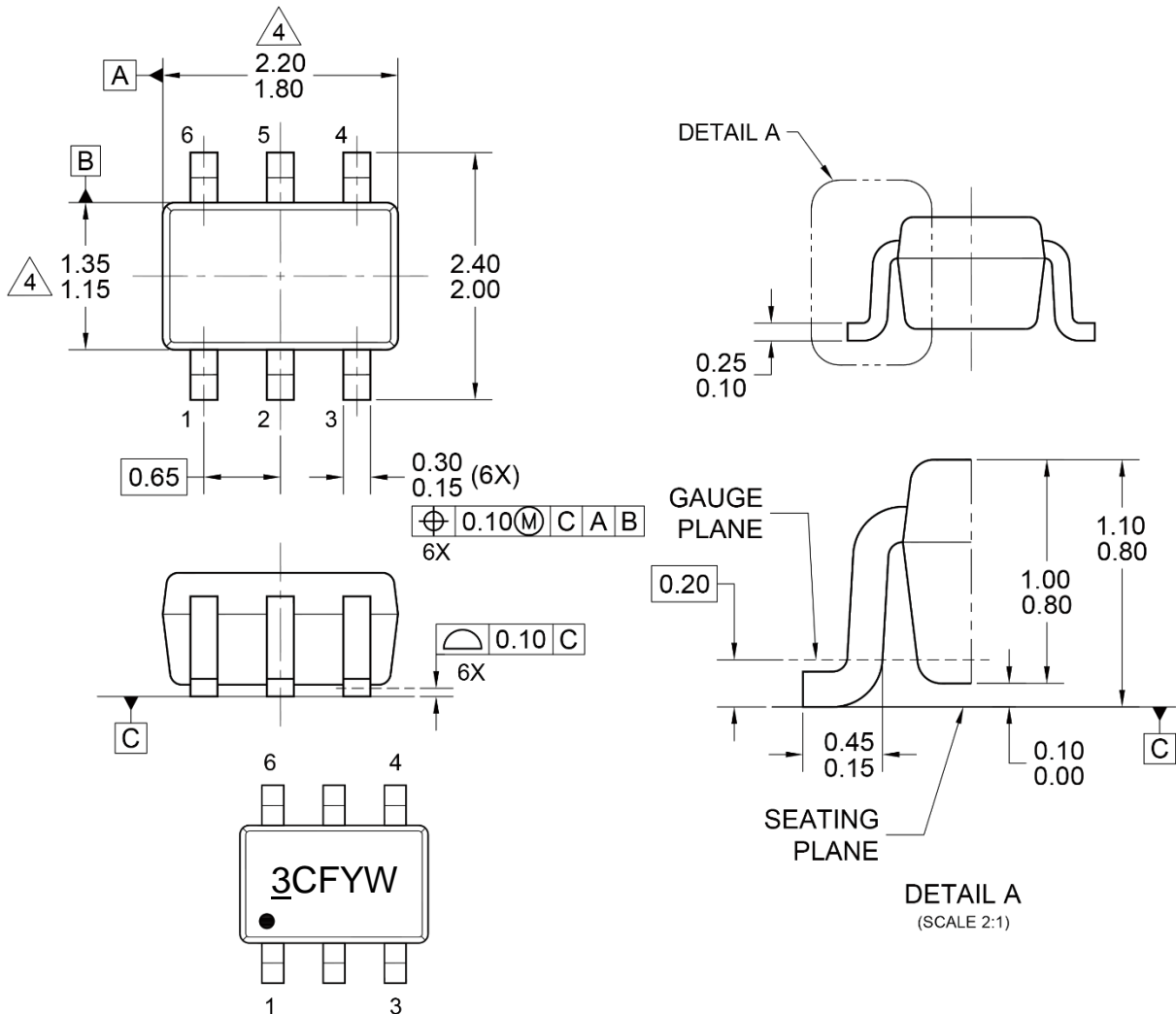
Fig.6 Base-Emitter Voltage vs. Collector Current



($T_A = 25^\circ\text{C}$ unless otherwise noted)
IC, COLLECTOR CURRENT (mA)

PACKAGE OUTLINE DIMENSIONS

SOT-363

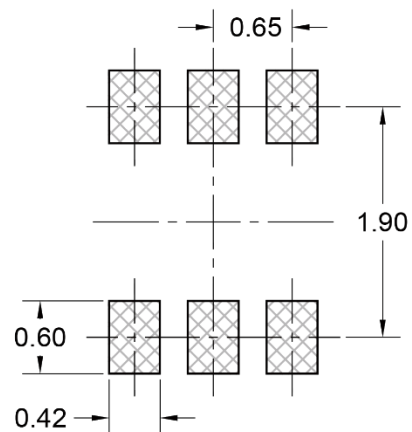


MARKING DIAGRAM

- 3C = Device marking
F = Factory code
Y = Year code
W = Bi-Week code (A~Z)

NOTES: UNLESS OTHERWISE SPECIFIED

- ALL DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- PACKAGE OUTLINE REFERENCE: JEITA ED-7500A, EIAJ SC-88.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- DWG NO. REF: HQ2SD07-SOT363-097 REV B.



SUGGESTED PAD LAYOUT

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